

STGF3NC120HD

N-CHANNEL 3A - 1200V TO-220FP FAST PowerMESH™ IGBT with Integral Damper Diode

Table 1: General Features

ТҮРЕ	V _{CES}	V _{CE(sat)} (Max) @25℃	lc @100°C
STGF3NC120HD	1200 V	< 2.8 V	3 A

- LOW ON-VOLTAGE DROP (V_{cesat})
- HIGH CURRENT CAPABILITY
- OFF LOSSES INCLUDE TAIL CURRENT
- HIGH SPEED

DESCRIPTION

This PowerMESH[™] IGBT is designed using the latest high voltage technology based on a patented strip layout. A new lifetime control allows good switching performance and low voltage drop. This IGBT featuring a co-packaged diode is optimized for horizontal deflection applications in small and medium sets.

APPLICATIONS

- HORIZONTAL DEFLECTION
- HOME APPLIANCE
- LIGHTING

Figure 1: Package

Figure 2: Internal Schematic Diagram

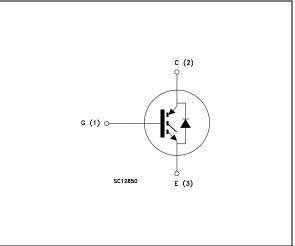


Table 2: Order Code

PART NUMBER	MARKING	PACKAGE	PACKAGING
STGF3NC120HD	GF3NC120HD	TO-220FP	TUBE

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	1200	V	
V_{ECR}	Emitter-Collector Voltage	20	V	
V_{GE}	Gate-Emitter Voltage	±20	V	
Ι _C	Collector Current (continuous) at T _C = 25°C	6	А	
I _C Collector Current (continuous) at T _C = 100°C		3	А	
I _{СМ} (∎)	Collector Current (pulsed)	10	А	
Ртот	Total Dissipation at $T_C = 25^{\circ}C$	25	W	
	Derating Factor	0.20	W/°C	
VISO	Insulation withstand voltage AC (t=1sec, Tc=25°C)	2500	V	
T _{stg}	Storage Temperature	-55 to 150	°C	
Tj	Operating Junction Temperature range	-55 to 150		

Table 3: Absolute Maximum ratings

(
) Pulse width limited by safe operating area

Table 4: Thermal Data

		Min.	Тур.	Max.	
Rthj-case	Thermal Resistance Junction-case			5.0	°C/W
Rthj-amb	Thermal Resistance Junction-ambient			62.5	°C/W
TL	Maximum Lead Temperature for Soldering Purpose (1.6 mm from case, for 10 sec.)		300		°C

ELECTRICAL CHARACTERISTICS (T_{CASE} =25°C UNLESS OTHERWISE SPECIFIED) Table 5: On/Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-Emitter Breakdown Voltage	I _C = 1 mA, V _{GE} = 0	1200			V
ICES	Collector cut-off Current $(V_{GE} = 0)$	V_{CE} = Max Rating, T_C = 25 °C V_{CE} = Max Rating, T_C = 125 °C			50 1	μA mA
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	$V_{GE} = \pm 20V$, $V_{CE} = 0$			±100	nA
V _{GE(th)}	Gate Threshold Voltage	$V_{CE} = V_{GE}, I_C = 250 \ \mu A$	2		5	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	V _{GE} = 15V, I _C = 3 A V _{GE} = 15V, I _C = 3 A, Tc= 125°C		2.3 2.2	2.8	V V

ELECTRICAL CHARACTERISTICS (CONTINUED) Table 6: Dynamic

Symbol	bol Parameter Test Conditions		ool Parameter Test Conditions Min.		Min.	Тур.	Max.	Unit
g _{fs} (1)	Forward Transconductance	$V_{CE} = 25 V, I_{C} = 3 A$		4		S		
Cies	Input Capacitance	$V_{CE} = 25 \text{ V}, \text{ f} = 1 \text{ MHz}, \text{ V}_{GE} = 0$		470		pF		
Coes	Output Capacitance			45		pF		
C _{res}	Reverse Transfer Capacitance			6		pF		
Q _g Q _{ge} Q _{gc}	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	$V_{CC} = 960 \text{ V}, I_C = 3 \text{ A}, V_{GE} = 15 \text{ V}$ (see Figure 22)		24 3 10	32	nC nC nC		
I _{CL}	Turn-off SOA minimum current		10			A		

(1) Pulsed: Pulse duration= 300 µs, duty cycle 1.5%

Table 7: Switching On

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on Delay Time Current Rise Time Turn-on Current Slope			15 3.5 880		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on Delay Time Current Rise Time Turn-on Current Slope	$V_{CC} = 480 \text{ V}, I_C = 3 \text{ A}$ R _G = 10 Ω , V _{GE} = 15V, Tj= 125°C (see Figure 20)		14.5 4 770		ns ns A/µs

Table 8: Switching Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _r (V _{off})	Off Voltage Rise Time	$V_{cc} = 800 \text{ V}, I_C = 3 \text{ A},$		72		ns
t _d (_{off})	Turn-off Delay Time	R _G = 10 Ω , V _{GE} = 15 V T _J = 25 °C		118		ns
t _f	Current Fall Time	(see Figure 20)		250		ns
t _r (V _{off})	Off Voltage Rise Time	$V_{cc} = 800 \text{ V}, I_C = 3 \text{ A},$		132		ns
t _d (_{off})	Turn-off Delay Time	R _G = 10 Ω , V _{GE} = 15 V Ti = 125 °C		210		ns
t _f	Current Fall Time	(see Figure 20)		470		ns

Table 9: Switching Energy

Symbol	Parameterr	Test Conditions	Min.	Тур.	Max	Unit
Eon (2) E _{off} (3) E _{ts}	Turn-on Switching Losses Turn-off Switching Loss Total Switching Loss			236 290 526		μJ μJ
Eon (2) E _{off} (3) E _{ts}	Turn-on Switching Losses Turn-off Switching Loss Total Switching Loss			360 620 980		μJ μJ

(2) Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & DIODE are at the same temperature (25°C and 125°C)
 (3) Turn-off losses include also the tail of the collector current.

Table 10: Collector-Emitter Diode

Symbol	Parameterr	Test Conditions	Min.	Тур.	Max	Unit
l _f I _{fm}	Forward Current Forward Current pulsed				3 12	A A
V _f	Forward On-Voltage	If = 1.5 A If = 1.5A, Tj = 125°C		1.6 1.3	2.0	V V
t _{rr} Q _{rr} I _{rm}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	If = 3 A, V_R = 40 V Tj = 25°C, di/dt = 100 A/µs (see Figure 23)		51 85 3.3		ns nC A
t _{rr} Q _{rr} I _{rm}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	If = 3 A, V_R = 40 V Tj = 125°C, di/dt = 100 A/µs (see Figure 23)		64 133 4.2		ns nC A

HV24060 lc(A) 60 $V_{GE} = 15V$ 14V 13\ 12\ 40 11 10V 9١ 20 8٧ 7١ 6٧ 0 3 6 9 12 $V_{CE}(V)$

Figure 3: Output Characteristics

Figure 4: Transconductance

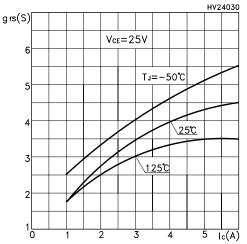


Figure 5: Collector-Emitter On Voltage vs Collector Current

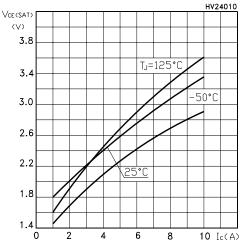


Figure 6: Transfer Characteristics

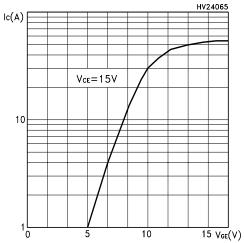


Figure 7: Collector-Emitter On Voltage vs Temperature

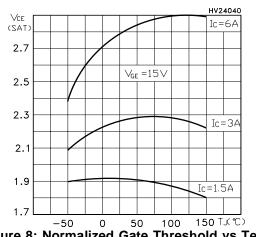
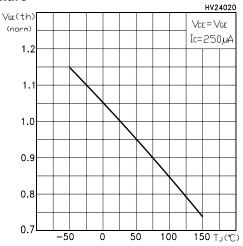


Figure 8: Normalized Gate Threshold vs Temperature



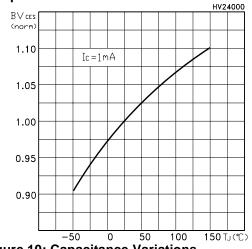
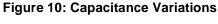


Figure 9: Normalized Breakdown Voltage vs Temperature



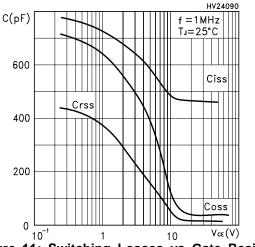


Figure 11: Switching Losses vs Gate Resistance

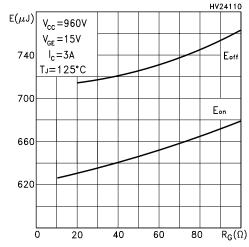


Figure 12: Gate Charge vs Gate-Emitter Voltage

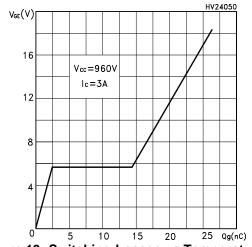
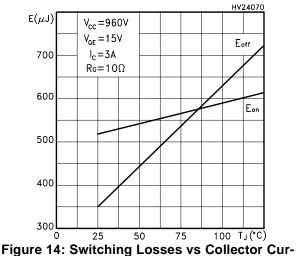
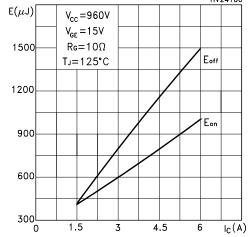


Figure 13: Switching Losses vs Temperature



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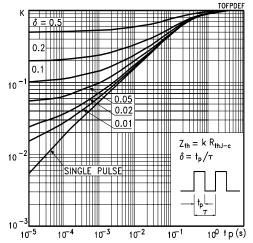
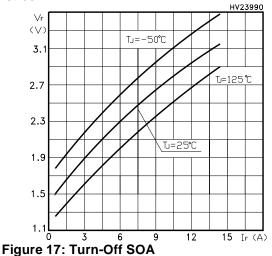


Figure 15: Thermal Impedance

Figure 16: Collector-Emitter Diode Characteristics



HV24080 HV24080 $T_{j=150C}$ $T_{j=150C}$ $T_{j=150C}$

Figure 18: Power Losses

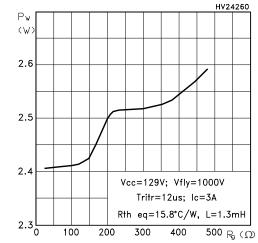


Figure 19: Power Losses

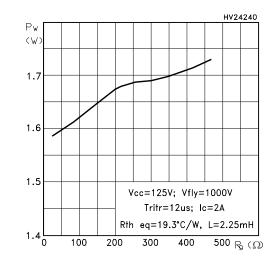


Figure 20: Test Circuit for Inductive Load Switching

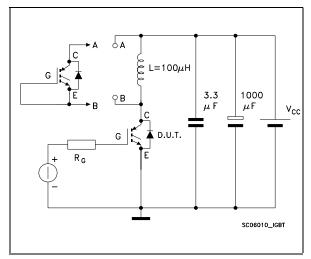


Figure 21: Switching Waveforms

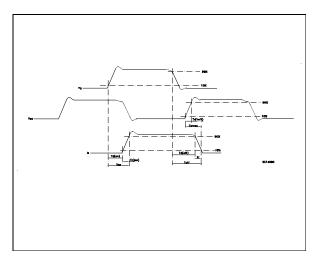


Figure 22: Gate Charge Test Circuit

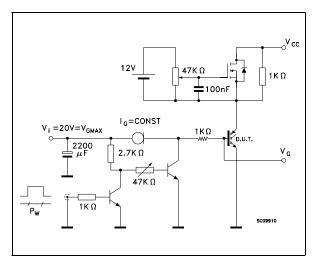
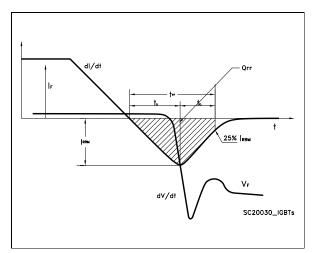


Figure 23: Diode Recovery Time Waveforms



TO-220FP MECHANICAL DATA

		mm.			inch	
DIM.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
Е	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
Н	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	.0385		0.417
L5	2.9		3.6	0.114		0.141
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126

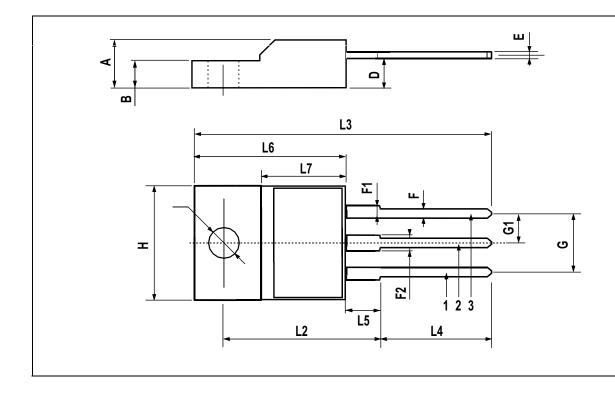


Table 11: Revision History

Date	Revision	Description of Changes
13-Dec-2004	1	First release
21-Jan-2005	2	Modified Curve 17

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